

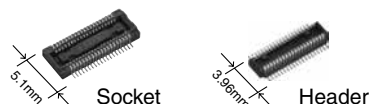
For board-to-board | For board-to-FPC

## Narrow pitch connectors (0.4mm pitch)

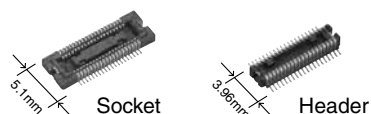
# P4 Series



### • Without soldering terminals

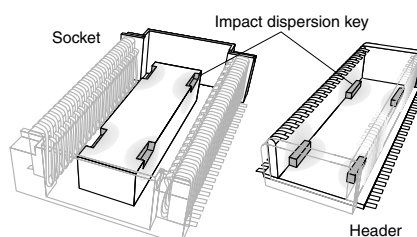


### • With soldering terminals


**RoHS compliant**

## FEATURES

1. 0.4 mm pitch and mated heights of 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm and 3.5 mm.
2. Strong resistance to adverse environments! Utilizes “**TOUGH CONTACT**” construction for high contact reliability.
3. Constructed with impact dispersion keys inside the body to disperse shocks when dropped.



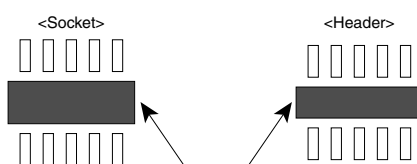
A high level of shock resistance is ensured by dispersing impact over the four locations where the socket indentations and header protrusions are mated together.

Note: The following number of pins are not supported due to suction surface factors.

- Without soldering terminals: 18 pin contacts or less
- With soldering terminals: 22 pin contacts or less

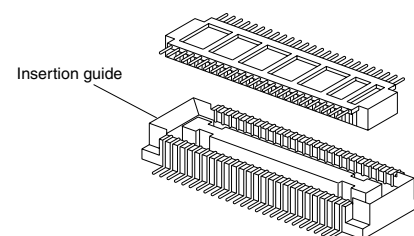
### 4. Construction makes designing devices easier.

- 1) The lower connector bottom surface construction prevents contact and shorts between the PCB and metal terminals. This enables freedom in pattern wiring, helping to make PCB's smaller.

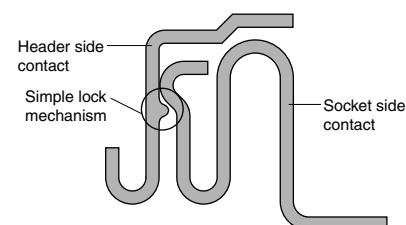


Connector bottom: Create any thru-hole and pattern wiring.

- 2) Guides are provided to take up any position shift and facilitate insertion.



- 3) Simple lock structure provides tactile feedback to ensure excellent mating/unmating operation feel.



### 5. Design facilitates efficient mounting.

Features a terminal flatness of 0.08 mm, construction resistant to creeping flux, and design that allows visual inspection of the soldered part.

### 6. Connectors for inspection available

## APPLICATIONS

Mobile devices, such as cellular phones, digital still cameras and digital video cameras.

AXK7, 8

ORDERING INFORMATION

AXK							G
7: Narrow Pitch Connector P4 (0.4 mm pitch) Socket 8: Narrow Pitch Connector P4 (0.4 mm pitch) Header							
Number of pins (2 digits)							
Mated height <Socket> 1: For mated height 1.5 mm 2: For mated height 2.0 mm 3: For mated height 2.5 mm and 3.0 mm 4: For mated height 3.5 mm <Header> 1: For mated height 1.5 mm, 2.0 mm and 2.5 mm 2: For mated height 3.0 mm and 3.5 mm							
Functions 2: With soldering terminals, without positioning bosses 4: Without soldering terminals, without positioning bosses							
Surface treatment (Contact portion / Terminal portion) <Socket> 7: Ni plating on base, Au plating on surface (for Ni barrier available) <Header> 5: Ni plating on base, Au plating on surface							
Other specifications <Header> W: V notch							
Packing G: 3,000 pieces embossed tape and plastic reel × 2*							
Notes: 1. Only a socket of mated height 3.5 mm: 2,000 pieces embossed tape and plastic reel × 2. 2. Please note that the models with a soldering terminals (8th digit of part number is "2") and those without a soldering terminals (8th digit of part number is "4") are shaped differently and are not compatible.							

## PRODUCT TYPES

### 1. Without soldering terminals **TOUGH CONTACT**

Mated height	Number of pins	Part number		Packing	
		Socket	Header	Inner carton	Outer carton
		<b>TOUGH CONTACT</b>	<b>TOUGH CONTACT</b>		
1.5 mm	14	AXK714147G	AXK814145WG	3,000 pieces	6,000 pieces
	20	AXK720147G	AXK820145WG		
	22	AXK722147G	AXK822145WG		
	24	AXK724147G	AXK824145WG		
	26	AXK726147G	AXK826145WG		
	30	AXK730147G	AXK830145WG		
	34	AXK734147G	AXK834145WG		
	40	AXK740147G	AXK840145WG		
	44	AXK744147G	AXK844145WG		
	50	AXK750147G	AXK850145WG		
	54	AXK754147G	AXK854145WG		
	60	AXK760147G	AXK860145WG		
	64	AXK764147G	AXK864145WG		
	70	AXK770147G	AXK870145WG		
	80	AXK780147G	AXK880145WG		
	100	AXK700147G	AXK800145WG		
2.0 mm	14	AXK714247G	AXK814145WG		
	20	AXK720247G	AXK820145WG		
	24	AXK724247G	AXK824145WG		
	26	AXK726247G	AXK826145WG		
	30	AXK730247G	AXK830145WG		
	40	AXK740247G	AXK840145WG		
	50	AXK750247G	AXK850145WG		
	60	AXK760247G	AXK860145WG		
	70	AXK770247G	AXK870145WG		
	80	AXK780247G	AXK880145WG		
2.5 mm	14	AXK714347G	AXK814145WG		
	20	AXK720347G	AXK820145WG		
	24	AXK724347G	AXK824145WG		
	30	AXK730347G	AXK830145WG		
	40	AXK740347G	AXK840145WG		
	50	AXK750347G	AXK850145WG		
	60	AXK760347G	AXK860145WG		
	70	AXK770347G	AXK870145WG		
	80	AXK780347G	AXK880145WG		
3.0 mm	20	AXK720347G	AXK820245WG		
	24	AXK724347G	AXK824245WG		
	30	AXK730347G	AXK830245WG		
	40	AXK740347G	AXK840245WG		
	50	AXK750347G	AXK850245WG		
	60	AXK760347G	AXK860245WG		
	80	AXK780347G	AXK880245WG		
3.5 mm	20	AXK720447G	AXK820245WG	Socket: 2,000 pieces Header: 3,000 pieces	Socket: 4,000 pieces Header: 6,000 pieces
	30	AXK730447G	AXK830245WG		
	40	AXK740447G	AXK840245WG		

Notes: 1. Regarding ordering units; During production: Please make orders in 1-reel units.

Samples for mounting confirmation: Available in units of 50 pieces. Please contact our sales office.

Samples: Small lot orders are possible.

2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our sales office.

# AXK7, 8

## 2. With soldering terminals **TOUGH CONTACT**

Mated height	Number of pins	Part number		Packing	
		Socket	Header	Inner carton	Outer carton
		<b>TOUGH CONTACT</b>	<b>TOUGH CONTACT</b>		
1.5 mm	10	AXK710127G	AXK810125WG	3,000 pieces	6,000 pieces
	34	AXK734127G	AXK834125WG		
	40	AXK740127G	AXK840125WG		
2.0 mm	34	AXK734227G	AXK834125WG		
2.5 mm	12	AXK712327G	AXK812125WG		
	20	AXK720327G	AXK820125WG		
	32	AXK732327G	AXK832125WG		
	40	AXK740327G	AXK840125WG		
3.0 mm	20	AXK720327G	AXK820225WG		
	36	AXK736327G	AXK836225WG		
	60	AXK760327G	AXK860225WG		
	70	AXK770327G	AXK870225WG		
	80	AXK780327G	AXK880225WG		
3.5 mm	60	AXK760427G	AXK860225WG	Socket: 2,000 pieces Header: 3,000 pieces	Socket: 4,000 pieces Header: 6,000 pieces
	70	AXK770427G	AXK870225WG		
	80	AXK780427G	AXK880225WG		

Notes: 1. Regarding ordering units; During production: Please make orders in 1-reel units.

Samples for mounting confirmation: Available in units of 50 pieces. Please contact our sales office.

Samples: Small lot orders are possible.

2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our sales office.

# SPECIFICATIONS

## 1. Characteristics

Item		Specifications	Conditions																		
Electrical characteristics	Rated current	0.3A/pin contact (Max. 5 A at total pin contacts)																			
	Rated voltage	60V AC/DC																			
	Breakdown voltage	150V AC for 1 min.	Detection current: 1mA																		
	Insulation resistance	Min. 1,000MΩ (initial)	Using 250V DC megger (applied for 1 min.)																		
	Contact resistance	Max. 70mΩ	Based on the contact resistance measurement method specified by JIS C 5402.																		
Mechanical characteristics	Composite insertion force	Max. 0.981N/pin contacts × pin contacts (initial)																			
	Composite removal force	Min. 0.0588N/pin contacts × pin contacts (Mated height 1.5 mm without soldering terminals type) Min. 0.118N/pin contacts × pin contacts All the other types except the above (Mated height 1.5 mm without soldering terminals type)																			
	Post holding force	Min. 0.981N/pin contacts	Measuring the maximum force. As the contact is axially pull out.																		
Environmental characteristics	Ambient temperature	−55°C to +85°C	No freezing at low temperatures																		
	Soldering heat resistance	Max. peak temperature of 260°C (on the surface of the PC board around the connector terminals)	Infrared reflow soldering																		
		300°C within 5 sec. 350°C within 3 sec.	Soldering iron																		
	Storage temperature	−55°C to +85°C (product only) −40°C to +50°C (emboss packing)	No freezing at low temperatures. No dew condensation.																		
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100MΩ, contact resistance max. 70mΩ	Conformed to MIL-STD-202F, method 107G <table><tr><th>Order</th><th>Temperature (°C)</th><th>Time (minutes)</th></tr><tr><td>1</td><td>−55<sup>0</sup><sub>3</sub></td><td>30</td></tr><tr><td>2</td><td>∅</td><td>Max. 5</td></tr><tr><td>3</td><td>85<sup>+3</sup><sub>0</sub></td><td>30</td></tr><tr><td>4</td><td>∅</td><td>Max. 5</td></tr><tr><td></td><td>−55<sup>0</sup><sub>3</sub></td><td></td></tr></table>	Order	Temperature (°C)	Time (minutes)	1	−55 <sup>0</sup> <sub>3</sub>	30	2	∅	Max. 5	3	85 <sup>+3</sup> <sub>0</sub>	30	4	∅	Max. 5		−55 <sup>0</sup> <sub>3</sub>	
	Order	Temperature (°C)	Time (minutes)																		
	1	−55 <sup>0</sup> <sub>3</sub>	30																		
	2	∅	Max. 5																		
	3	85 <sup>+3</sup> <sub>0</sub>	30																		
4	∅	Max. 5																			
	−55 <sup>0</sup> <sub>3</sub>																				
Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100MΩ, contact resistance max. 70mΩ	Bath temperature 40±2°C, humidity 90 to 95% R.H.																			
Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100MΩ, contact resistance max. 70mΩ	Bath temperature 35±2°C, saltwater concentration 5±1%																			
H <sub>2</sub> S resistance (header and socket mated)	48 hours, contact resistance max. 70mΩ	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.																			
Lifetime characteristics	Insertion and removal life	50 times	Repeated insertion and removal speed of max. 200 times/hours																		
Unit weight		Mated height 1.5mm, 20 pin contacts; Socket: 0.04g Header: 0.02g																			

## 2. Material and surface treatment

Part name	Material	Surface treatment
Molded portion	LCP resin (UL94V-0)	—
Contact and Post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) However, upper terminal of Ni barrier production: Exposed over Ni The area adjacent to the terminal of the sockets on models with Ni barrier is exposed to Ni on base.
Soldering terminals portion	Copper alloy	Ni plating on base, Sn plating on surface (Except for front terminal)

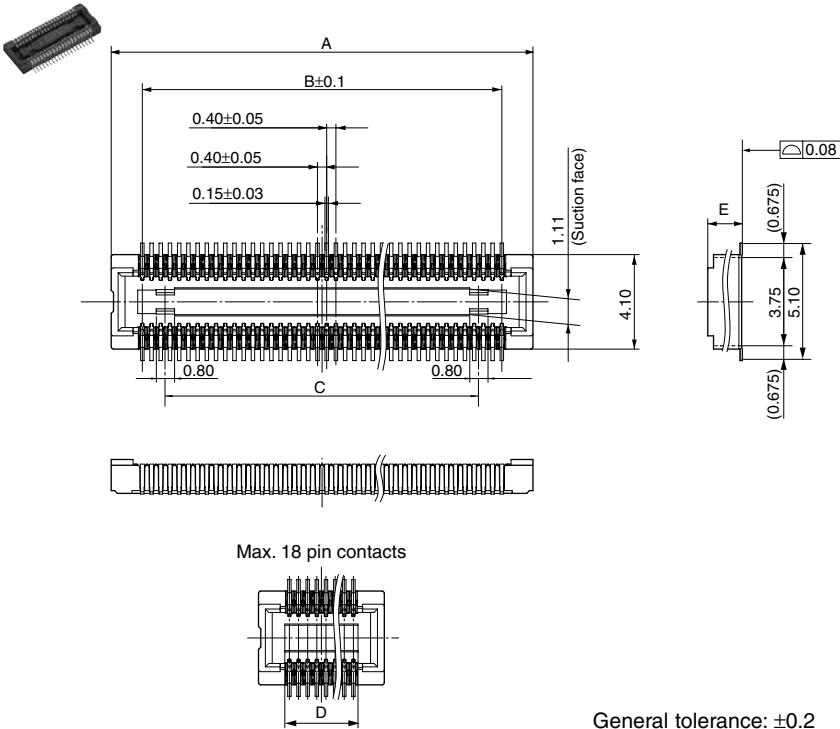
AXK7, 8

**DIMENSIONS** (Unit: mm) The CAD data of the products with a **CAD Data** mark can be downloaded from: <http://industrial.panasonic.com/ac/e/>

1. Without Soldering Terminals

Socket (Mated height: 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm and 3.5 mm)

CAD Data



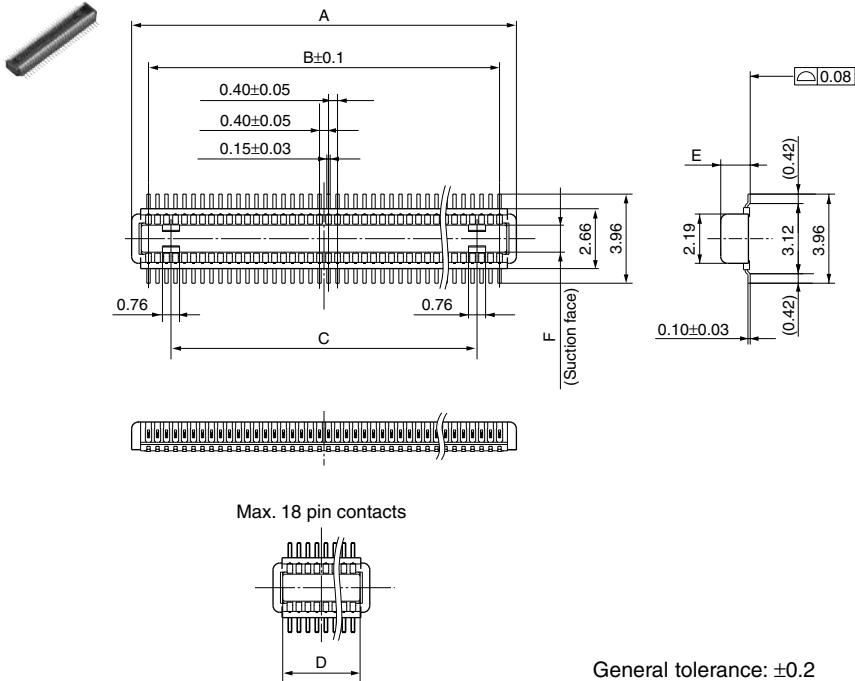
Dimension table (mm)

Number of pins/ dimension	A	B	C	D
14	5.10	2.40	—	2.80
20	6.30	3.60	1.60	—
22	6.70	4.00	2.00	—
24	7.10	4.40	2.40	—
26	7.50	4.80	2.80	—
30	8.30	5.60	3.60	—
34	9.10	6.40	4.40	—
40	10.30	7.60	5.60	—
44	11.10	8.40	6.40	—
50	12.30	9.60	7.60	—
54	13.10	10.40	8.40	—
60	14.30	11.60	9.60	—
64	15.10	12.40	10.40	—
70	16.30	13.60	11.60	—
80	18.30	15.60	13.60	—
100	22.30	19.60	17.60	—

Mated height/dimension	E
1.5mm	1.50
2.0mm	1.92
2.5mm, 3.0mm	2.42
3.5mm	2.92

Header (Mated height: 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm and 3.5 mm)

CAD Data

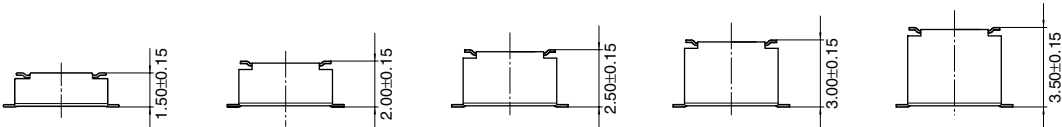


Dimension table (mm)

Number of pins/ dimension	A	B	C	D
14	3.90	2.40	—	3.04
20	5.10	3.60	1.60	—
22	5.50	4.00	2.00	—
24	5.90	4.40	2.40	—
26	6.30	4.80	2.80	—
30	7.10	5.60	3.60	—
34	7.90	6.40	4.40	—
40	9.10	7.60	5.60	—
44	9.90	8.40	6.40	—
50	11.10	9.60	7.60	—
54	11.90	10.40	8.40	—
60	13.10	11.60	9.60	—
64	13.90	12.40	10.40	—
70	15.10	13.60	11.60	—
80	17.10	15.60	13.60	—
100	21.10	19.60	17.60	—

Mated height/dimension	E	F
1.5mm, 2.0mm, 2.5mm	1.31	1.20
3.0mm, 3.5mm	2.26	1.26

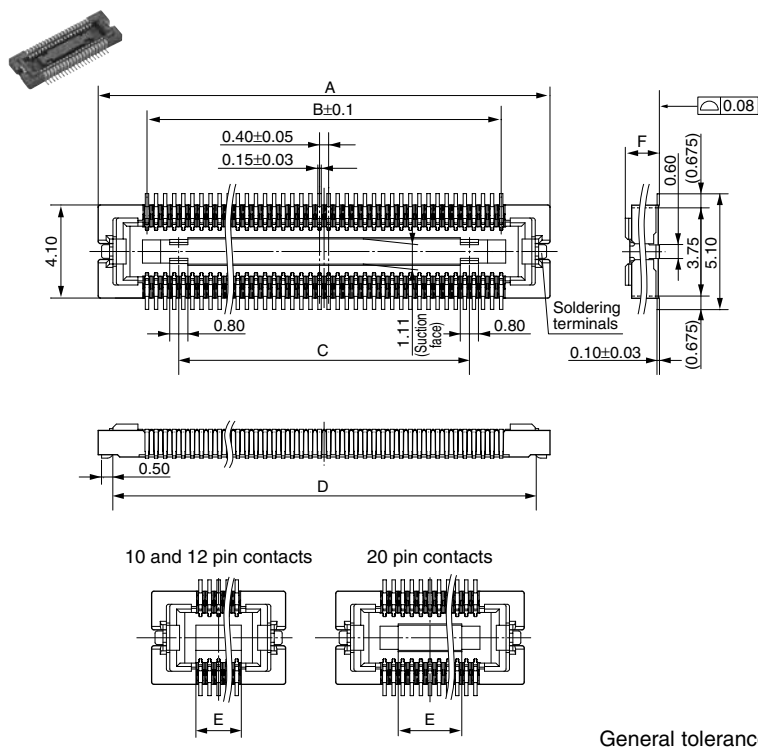
Socket and Header are mated



## 2. With Soldering Terminals

Socket (Mated height: 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm and 3.5 mm)

### CAD Data



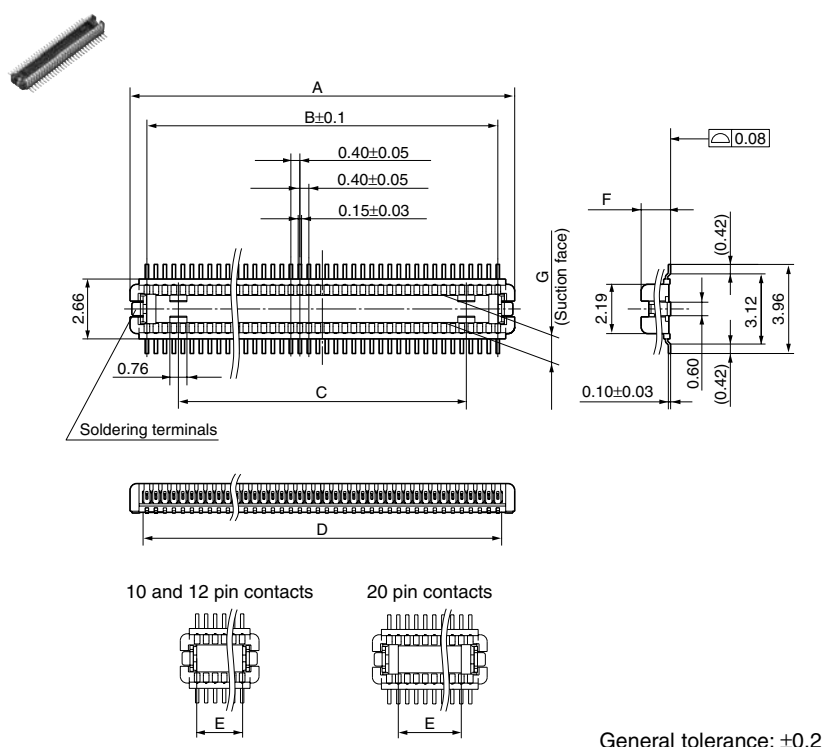
Dimension table (mm)

Number of pins/ dimension	A	B	C	D	E
10	5.90	1.60	—	4.60	2.00
12	6.30	2.00	—	5.00	2.40
20	7.90	3.60	—	6.60	2.40
32	10.30	6.00	3.20	9.00	—
34	10.70	6.40	3.60	9.40	—
36	11.10	6.80	4.00	9.40	—
40	11.90	7.60	4.80	10.60	—
60	15.90	11.60	8.80	14.60	—
70	17.90	13.60	10.80	16.60	—
80	19.90	15.60	12.80	18.60	—

Mated height/dimension	F
1.5mm	1.50
2.0mm	1.92
2.5mm, 3.0mm	2.42
3.5mm	2.92

Header (Mated height: 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm and 3.5 mm)

### CAD Data

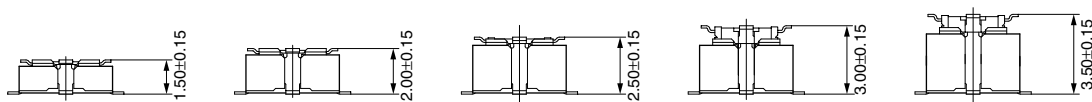


Dimension table (mm)

Number of pins/ dimension	A	B	C	D	E
10	3.10	1.60	—	1.94	1.64
12	3.50	2.00	—	2.34	2.04
20	5.10	3.60	—	3.94	2.80
32	7.50	6.00	3.20	6.34	—
34	7.90	6.40	3.60	6.74	—
36	8.30	6.80	4.00	7.14	—
40	9.10	7.60	4.80	7.94	—
60	13.10	11.60	8.80	11.94	—
70	15.10	13.60	10.80	13.94	—
80	17.10	15.60	12.80	15.94	—

Mated height/dimension	F	G
1.5mm, 2.0mm, 2.5mm	1.31	1.20
3.0mm, 3.5mm	2.26	1.26

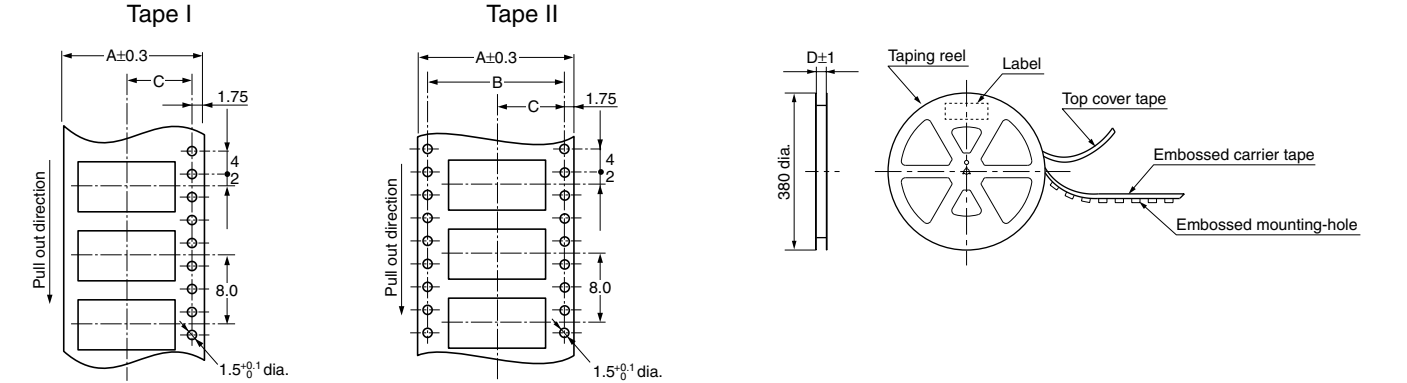
Socket and Header are mated.



AXK7, 8

EMBOSSSED TAPE DIMENSIONS (unit: mm, Common for respective contact type, socket and header)

- Tape dimensions (Conforming to JIS C 0806:1990.  
However, some tapes have mounting hole pitches that do not comply with the standard.)
- Plastic reel dimensions (Conforming to EIAJ ET-7200B)



Dimension table (mm)

1. Without Soldering Terminals

Mated height	Number of pins		Type of taping	A	B	C	D	Quantity per reel
	Socket	Header						
Common for socket and header: 1.5 mm, 2.0 mm, 2.5 mm and 3.0 mm Header: 3.5 mm	Max. 18	Max. 18	Tape I	16.00	—	7.50	17.40	3,000
	20 to 70	20 to 70	Tape I	24.00	—	11.50	25.40	3,000
	80 to 100	80 to 100	Tape II	32.00	28.40	14.20	33.40	3,000
Socket: 3.5 mm	20 to 40		Tape I	24.00	—	11.50	25.40	2,000

2. With Soldering Terminals

Mated height	Number of pins		Type of taping	A	B	C	D	Quantity per reel
	Socket	Header						
Common for socket and header: 1.5 mm, 2.0 mm, 2.5 mm and 3.0 mm Header: 3.5 mm	Max. 18	Max. 18	Tape I	16.00	—	7.50	17.40	3,000
	20 to 60	20 to 70	Tape I	24.00	—	11.50	25.40	3,000
	70 to 80	80	Tape II	32.00	28.40	14.20	33.40	3,000
Socket: 3.5 mm	60		Tape I	24.00	—	11.50	25.40	2,000
	70 to 80		Tape II	32.00	28.40	14.20	33.40	2,000

3. Connector orientation with respect to direction of progress of embossed tape

1) Without soldering terminals

Type

Direction of tape progress

Common for P4

Socket

Header

Note: There is no indication on this product regarding top-bottom or left-right orientation.

2) With soldering terminals

Type

Direction of tape progress

Common for P4

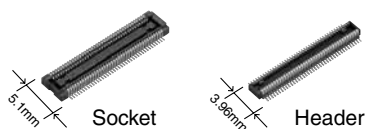
Socket

Header

Note: There is no indication on this product regarding top-bottom or left-right orientation.



For board-to-board    For board-to-FPC

**Connectors for  
inspection usage  
(0.4mm pitch)****P4 Series****RoHS compliant****FEATURES**

- 1. 3,000 mating and unmating cycles**
- 2. Same external dimensions and foot pattern as standard type.**
- 3. Improved mating**

Insertion and removal easy due to a reduction in mating retention force. This is made possible by a simple locking structure design.

Note: Mating retention force cannot be warranted.

**APPLICATIONS**

Ideal for module unit inspection and equipment assembly inspection

**TABLE OF PRODUCT TYPES**

☆: Available for sale

Product name	Number of pins																	
	10	12	14	20	22	24	26	30	34	40	44	50	54	60	64	70	80	100
P4 for inspection without soldering terminals			☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆	☆
P4 for inspection with soldering terminals	☆	☆		☆					☆	☆				☆			☆	

- Notes: 1. You can use with each mated height in common.  
 2. Please inquire about number of pins other than those shown above.  
 3. Please inquire with us regarding availability.  
 4. Please keep the minimum order quantities no less than 50 pieces per lot.  
 5. Please inquire if further information is needed.

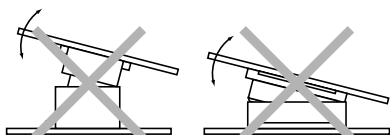
**PRODUCT TYPES**

Specifications			Part No.	Specifications			Part No.
Socket	With soldering terminals	Without positioning bosses	AXK7E**26G	Header	With soldering terminals	Without positioning bosses	AXK8E**26WG
	Without soldering terminals	Without positioning bosses	AXK7E**46G		Without soldering terminals	Without positioning bosses	AXK8E**46WG

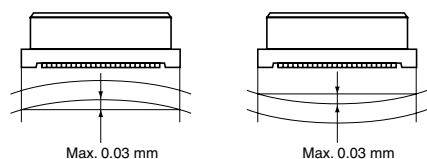
- Notes: 1. When placing an order, substitute the "\*" (asterisk) in the above part number with the number of pins for the specific connector.  
 2. The above part numbers are for connectors without positioning bosses, which are standard. When ordering connectors with positioning bosses, please contact our local sales office.

## NOTES

1. As shown below, excess force during insertion may result in damage to the connector or removal of the solder. Also, to prevent connector damage please confirm the correct position before mating connectors.



2. Keep the PC board warp no more than 0.03 mm in relation to the overall length of the connector.



### 3. Recommended PC board and metal mask patterns

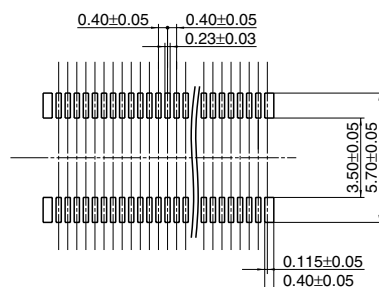
Connectors are mounted with high pitch density, intervals of 0.35 mm, 0.4 mm or 0.5 mm.

In order to reduce solder and flux rise, solder bridges and other issues make sure the proper levels of solder is used. The figures to the right are recommended metal mask patterns. Please use them as a reference.

#### 1) Without soldering terminals

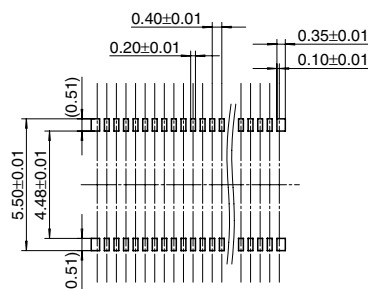
##### Socket

##### Recommended PC board pattern (TOP VIEW)



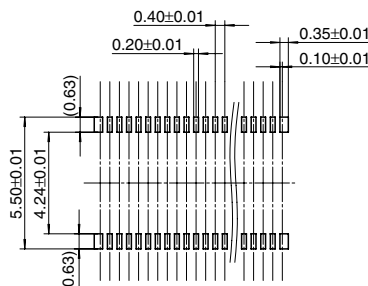
##### Recommended metal mask pattern

Metal mask thickness: When 150 μm  
(Opening area ratio: 40%)



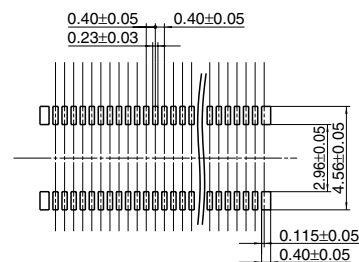
##### Recommended metal mask pattern

Metal mask thickness: When 120 μm  
(Opening area ratio: 50%)



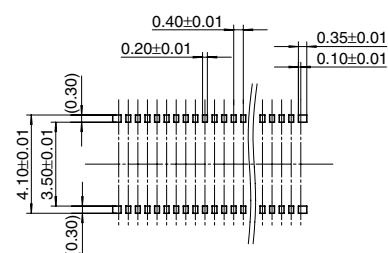
##### Header

##### Recommended PC board pattern (TOP VIEW)



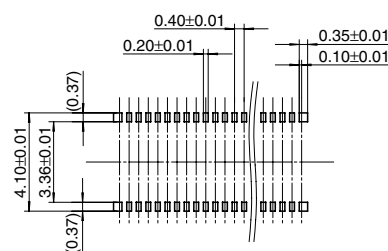
##### Recommended metal mask pattern

Metal mask thickness: When 150 μm  
(Opening area ratio: 32%)



##### Recommended metal mask pattern

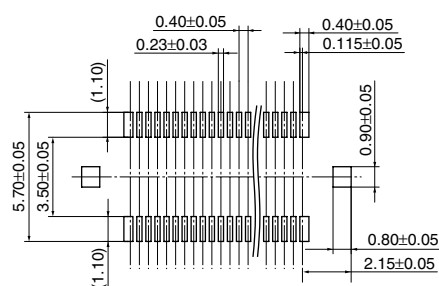
Metal mask thickness: When 120 μm  
(Opening area ratio: 40%)



## 2) With soldering terminals

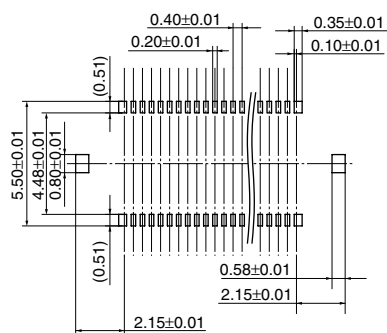
## Socket

## Recommended PC board pattern (TOP VIEW)



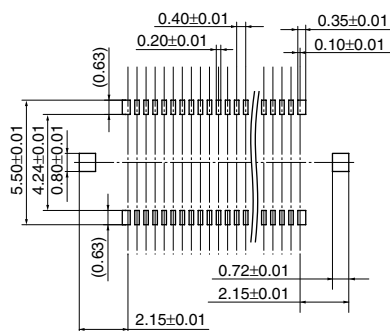
## Recommended metal mask pattern

Metal mask thickness: When 150  $\mu\text{m}$   
 (Terminal portion opening area ratio: 40%)  
 (Metal portion opening area ratio: 65%)



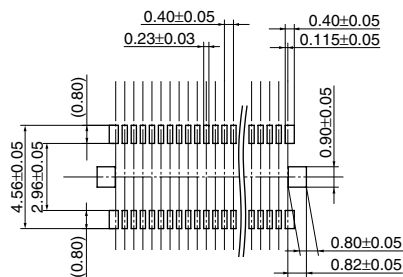
## Recommended metal mask pattern

Metal mask thickness: When 120  $\mu\text{m}$   
 (Terminal portion opening area ratio: 50%)  
 (Metal portion opening area ratio: 80%)



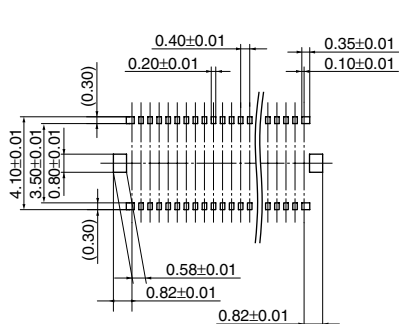
## Header

## Recommended PC board pattern (TOP VIEW)



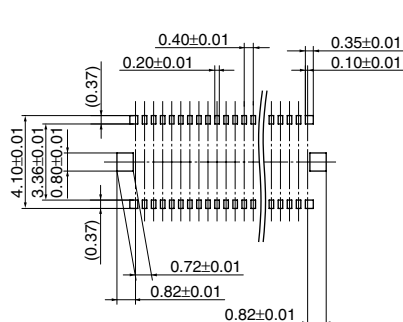
## Recommended metal mask pattern

Metal mask thickness: When 150  $\mu\text{m}$   
 (Terminal portion opening area ratio: 32%)  
 (Metal portion opening area ratio: 65%)



## Recommended metal mask pattern

Metal mask thickness: When 120  $\mu\text{m}$   
 (Terminal portion opening area ratio: 40%)  
 (Metal portion opening area ratio: 80%)



Please refer to the latest product specifications when designing your product.

# Notes on Using Narrow pitch Connectors

## Regarding the design of devices and PC board patterns

1) When connecting several connectors together by stacking, make sure to maintain proper accuracy in the design of structure and mounting equipment so that the connectors are not subjected to twisting and torsional forces.

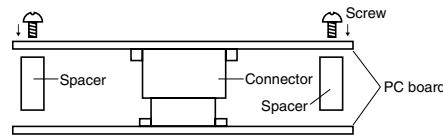
2) With mounting equipment, there may be up to a  $\pm 0.2$  to  $0.3$ -mm error in positioning. Be sure to design PC boards and patterns while taking into consideration the performance and abilities of the required equipment.

3) Some connectors have tabs embossed on the body to aid in positioning. When using these connectors, make sure that the PC board is designed with positioning holes to match these tabs.

4) To ensure the required mechanical strength when soldering the connector terminals, make sure the PC board meets recommended PC board pattern design dimensions given.

5) For all connectors of the narrow pitch series, to prevent the PC board from coming off during vibrations or impacts, and to prevent loads from falling directly on the soldered portions, be sure to design some means to fix the PC board in place.

### Example) Secure in place with screws



When connecting PC boards, take appropriate measures to prevent the connector from coming off.

6) Notes when using a FPC.

(1) When the connector is soldered to an FPC board, during its insertion and removal procedures, forces may be applied to the terminals and cause the soldering to come off. It is recommended to use a reinforcement board on the

backside of the FPC board to which the connector is being connected. Please make the reinforcement board dimensions bigger than the outer limits of the recommended PC board pattern (should be approximately 1 mm greater than the outer limit).

Material should be glass epoxy or polyimide, and the thickness should be between  $0.2$  and  $0.3$  mm.

(2) Collisions, impacts, or turning of FPC boards, may apply forces on the connector and cause it to come loose. Therefore, make to design retaining plates or screws that will fix the connector in place.

7) The narrow pitch connector series is designed to be compact and thin. Although ease of handling has been taken into account, take care when mating the connectors, as displacement or angled mating could damage or deform the connector.

## Regarding the selection of the connector placement machine and the mounting procedures

1) Select the placement machine taking into consideration the connector height, required positioning accuracy, and packaging conditions.

2) Be aware that if the catching force of the placement machine is too great, it may deform the shape of the connector body or connector terminals.

3) Be aware that during mounting, external forces may be applied to the connector contact surfaces and terminals and cause deformations.

4) Depending on the size of the connector being used, self alignment may not be possible. In such cases, be sure to carefully position the terminal with the PC board pattern.

5) The positioning bosses give an approximate alignment for positioning on the PC board. For accurate positioning of the connector when mounting it to the PC board, we recommend using an automatic positioning machine.

6) Excessive mounter chucking force may deform the molded or metal part of the connector. Consult us in advance if chucking is to be applied.

# Notes on Using Narrow pitch Connectors

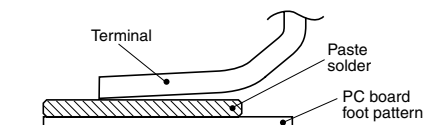
## Regarding soldering

### 1. Reflow soldering

1) Measure the recommended profile temperature for reflow soldering by placing a sensor on the PC board near the connector surface or terminals. (The setting for the sensor will differ depending on the sensor used, so be sure to carefully read the instructions that comes with it.)

2) As for cream solder printing, screen printing is recommended.

3) To determine the relationship between the screen opening area and the PC-board foot pattern area, refer to the diagrams in the recommended patterns for PC boards and metal masks. Make sure to use the terminal tip as a reference position when setting. Avoid an excessive amount of solder from being applied, otherwise, interference by the solder will cause an imperfect contact.



4) Consult us when using a screen-printing thickness other than that recommended.

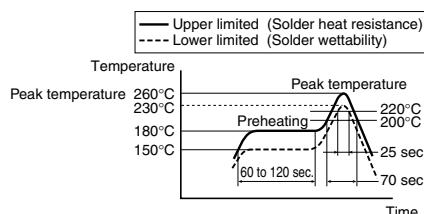
5) When mounting on both sides of the PC board and the connector is mounting on the underside, use adhesives or other means to ensure the connector is properly fixed to the PC board. (Double reflow soldering on the same side is possible.)

6) N<sub>2</sub> reflow, conducting reflow soldering in a nitrogen atmosphere, increases the solder flow too greatly, enabling wicking to occur. Make sure that the solder feed rate and temperature profile are appropriate.

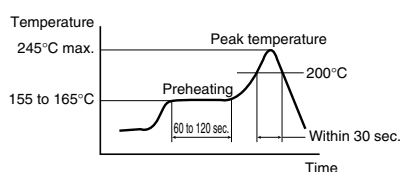
### Soldering conditions

Please use the reflow temperature profile conditions recommended below for reflow soldering. Please contact us before using a temperature profile other than that described below (e.g. lead-free solder).

- Narrow pitch connectors (except P8 type)



- Narrow pitch connector (P8)



For products other than the ones above, please refer to the latest product specifications.

7) The temperatures are measured at the surface of the PC board near the connector terminals. (The setting for the sensor will differ depending on the sensor used, so be sure to carefully read the instructions that comes with it.)

8) The temperature profiles given in this catalog are values measured when using the connector on a resin-based PC board. When performed reflow soldering on a metal board (iron, aluminum, etc.) or a metal table to mount on a FPC, make sure there is no deformation or discoloration of the connector beforehand and then begin mounting.

9) Consult us when using a screen-printing thickness other than that recommended.

10) Some solder and flux types may cause serious solder or flux creeping. Solder and flux characteristics should be taken into consideration when setting the reflow soldering conditions.

### 2. Hand soldering

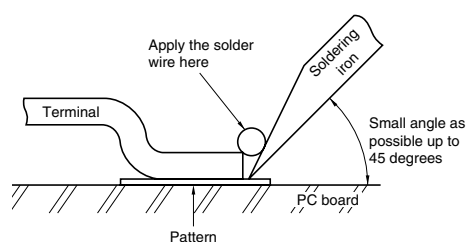
1) Set the soldering iron so that the tip temperature is less than that given in the table below.

Table A

Product name	Soldering iron temperature
SMD type connectors	300°C within 5 sec. 350°C within 3 sec.

2) Do not allow flux to spread onto the connector leads or PC board. This may lead to flux rising up to the connector inside.

3) Touch the soldering iron to the foot pattern. After the foot pattern and connector terminal are heated, apply the solder wire so it melts at the end of the connector terminals.



4) Be aware that soldering while applying a load on the connector terminals may cause improper operation of the connector.

5) Thoroughly clean the soldering iron.

6) Flux from the solder wire may get on the contact surfaces during soldering operations. After soldering, carefully check the contact surfaces and clean off any solder before use.

7) For soldering of prototype devices during product development, you can perform soldering at the necessary locations by heating with a hot-air gun by applying cream solder to the foot pattern beforehand. However, at this time, make sure that the air pressure does not move connectors by carefully holding them down with tweezers or other similar tool. Also, be careful not to go too close to the connectors and melt any of the molded components.

8) If an excessive amount of solder is applied during manual soldering, the solder may creep up near the contact points, or solder interference may cause imperfect contact.

### 3. Solder reworking

1) Finish reworking in one operation.

2) For reworking of the solder bridge, use a soldering iron with a flat tip. To prevent flux from climbing up to the contact surfaces, do not add more flux.

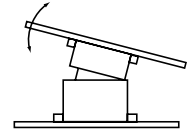
3) Keep the soldering iron tip temperature below the temperature given in Table A.

## Handling Single Components

- 1) Make sure not to drop or allow parts to fall from work bench
- 2) Excessive force applied to the terminals could cause warping, come out, or weaken the adhesive strength of the solder. Handle with care.
- 3) Repeated bending of the terminals may cause terminals to break.

- 4) Do not insert or remove the connector when it is not soldered. Forcibly applied external pressure on the terminals can weaken the adherence of the terminals to the molded part or cause the terminals to lose their evenness.
- 5) Excessive prying-force applied to one end may cause product breakage and separation of the solder joints at the terminal.

Excessive force applied for insertion in a pivot action as shown may also cause product breakage. Align the header and socket positions before connecting them.



## Cleaning flux from PC board

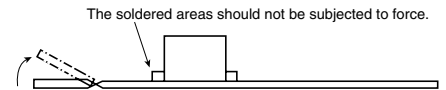
- 1) To increase the cleanliness of the cleaning fluid and cleaning operations, prepare equipment for cleaning process beginning with boil cleaning, ultrasonic cleaning, and then vapor cleaning.
- 2) Carefully oversee the cleanliness of the cleaning fluids to make sure that the contact surfaces do not become dirty from the cleaning fluid itself.

- 3) Since some powerful cleaning solutions may dissolve molded components of the connector and wipe off or discolor printed letters, we recommend aqua pura electronic parts cleaners. Please consult us if you wish to use other types of cleaning fluids.
- 4) Please note that the surfaces of molded parts may whiten when cleaned with alcohol.

## Handling the PC board

### • Handling the PC board after mounting the connector

When cutting or bending the PC board after mounting the connector, be careful that the soldered sections are subjected to excessive force.



## Storage of connectors

- 1) To prevent problems from voids or air pockets due to heat of reflow soldering, avoid storing the connectors in areas of high humidity. When storing the connectors for more than six months, be sure to consider storage area where the humidity is properly controlled.
- 2) Depending on the connector type, the color of the connector may vary from connector to connector depending on when it is produced.

- Some connectors may change color slightly if subjected to ultraviolet rays during storage. This is normal and will not affect the operation of the connector.
- 3) When storing the connectors with the PC boards assembled and components already set, be careful not to stack them up so the connectors are subjected to excessive forces.

- 4) Avoid storing the connectors in locations with excessive dust. The dust may accumulate and cause improper connections at the contact surfaces.

## Other Notes

- 1) These products are made for the design of compact and lightweight devices and therefore the thickness of the molded components has been made very thin. Therefore, be careful during insertion and removal operations for excessive forces applied may damage the products.
- 2) Dropping of the products or rough mishandling may bend or damage the terminals and possibly hinder proper reflow soldering.

- 3) Before soldering, try not to insert or remove the connector more than absolutely necessary.
- 4) When coating the PC board after soldering the connector to prevent the deterioration of insulation, perform the coating in such a way so that the coating does not get on the connector.
- 5) There may be variations in the colors of products from different production lots. This is normal.

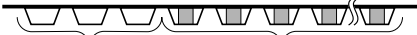
- 6) The connectors are not meant to be used for switching.
- 7) Be sure not to allow external pressure to act on connectors when assembling PCBs or moving in block assemblies.

# Notes on Using Narrow pitch Connectors

## Regarding sample orders to confirm proper mounting

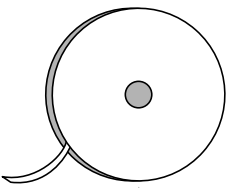
When ordering samples to confirm proper mounting with the placement machine, connectors are delivered in 50-piece units in the condition given right. Consult a sale representative for ordering sample units.

Condition when delivered from manufacturing



Embossed tape amount required for the mounting

Required number of products for sample production (Unit 50 pcs.)



Reel  
(Delivery can also be made on a reel by customer request.)

Please refer to the latest product specifications when designing your product.

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